## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Daniel Yap, et al. ) Re: Preliminary Amendment

) Group: unknown Serial No.: Not yet assigned )

) Examiner: unknown Filed: concurrently herewith )

) Our Ref: B-3752DIV 619413-2

For: "PRECISION ELECTROPLATED SOLDER)

BUMPS AND METHOD FOR

MANUFACTURING THEREOF" ) Date: January 15, 2002

Commissioner of Patents and Trademarks BOX NEW PATENT APPLICATION Washington, D.C. 20231

Sir:

The above-identified application is a divisional of pending prior U.S. Patent Application Serial No. <u>09/522,803</u> filed on <u>March 9, 2001</u>. Prior to examining this divisional application, it is respectfully requested that the following amendments be made:

## IN THE CLAIMS

Please cancel Claims 1 - 20, as filed. Therefore, examination of Claims 21 - 31, as filed, is requested.

## REMARKS

Amendment of the subject application is respectfully requested.

Respectfully submitted,

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